

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Issey YAMAMOTO	12/27/2005
Naoki KAISE	12/29/2005
Yutaka MORIKITA	12/28/2005
RECEIVING PARTY DATA	
Name:	Murata Manufacturing Co., Ltd.
Street Address:	10-1 Higashikotari 1-chome
Internal Address:	Nagaokakyo-shi
City:	Kyoto-fu
State/Country:	JAPAN
Postal Code:	617-8555
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	10595259
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NAME OF SUBMITTER:	Michelle Rhodes

OP \$40.00 10595259

Total Attachments: 2
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ASSIGNMENT (WORLDWIDE)

WHEREAS We, **Issey YAMAMOTO, Naoki KAISE**, and **Yutaka MORIKITA** (hereinafter referred to as ASSIGNOR), have invented and own a certain invention entitled **INTERNAL CONDUCTOR CONNECTION STRUCTURE AND MULTILAYER SUBSTRATE** for which application for Letters Patent of the United States has been

_____ executed on even date herewith;
X filed on I.A. 3/3/06 as Serial No. 10/595,259.

WHEREAS, **Murata Manufacturing Co., Ltd., 10-1, Higashikotari 1-chome, Nagaokakyo-shi, Kyoto-fu Japan 617-8555** (hereinafter referred to as ASSIGNEE), is desirous of acquiring the entire interest in, to and under said invention and the United States Letters Patent to be obtained therefor;

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that in consideration of the payment by ASSIGNEE to ASSIGNOR of the sum of One Dollar (\$1.00), the receipt of which is hereby acknowledged, and for other good and valuable consideration, ASSIGNOR hereby sells, assigns and transfers to ASSIGNEE the full and exclusive right, title and interest to the said invention and all Letters Patent of the United States to be obtained therefor on said application or any continuation, division, renewal, substitute or reissue thereof for the full term or terms for which the same may be granted; and all Letters Patent and applications therefor through the world, including all the rights accruing by virtue of the International Convention for the Protection of Industrial Property.

ASSIGNOR hereby covenants that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale;

ASSIGNOR further covenants that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent as may be known and accessible to ASSIGNOR and will testify as to the same in any interference or litigation related thereto and will promptly execute and deliver to ASSIGNEE or its legal representative any and all papers, instruments or affidavits required to apply for, obtain, maintain and enforce said application, said invention and said Letters Patent which may be necessary or desirable to carry out the purposes hereof.

Dated: 12/27/2005

Issey Yamamoto
Issey YAMAMOTO

Dated: 12/27/2005

Naoki Kaize
Naoki KAISE

Dated: 12/28/2005

Yutaka Morikita
Yutaka MORIKITA